

***LBI-38722A***

# **Maintenance Manual**

## **FRONT PANEL ASSEMBLY**

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DESCRIPTION

The Panel Control, Display and Dual Tone Multi Frequency (DTMF) Switch boards are housed in the Front Panel Assembly of the EDACS FMD mobile radio (Figure 1). The Display board contains the control switches, indicators, and display used to communicate information between the radio and the operator. The Panel Control board interfaces and processes signals between the Display board and the rest of the radio.

CIRCUIT ANALYSIS

PANEL CONTROL BOARD

The Panel Control board interfaces between the Display board, the System Control board, DTMF SW board (System model), speaker, microphone, and the MDT connector. The board contains an 87552 microcontroller (IC921), voltage regulators, power reset and interface circuitry, and backlighting control.

Power enters the board through connector P921-2 from the System Control board. Switched A + (SW A +) is applied to two voltage regulators (IC923 and IC924). Regulator IC923 provides + 5 Vdc to power the logic circuitry, and IC924 provides + 9 Vdc for the backlight LED indicators. Power-on reset is provided by the 5-volt regulator (RST line) and is applied through inverter TR921 to the RESET input of the microcontroller (IC921-15).

Microphone connections are made to the board through J923. No audio processing is performed on the Control Panel board and the microphone lines (MIC HI and MIC LO) are passed to the System Control board through P921-1.

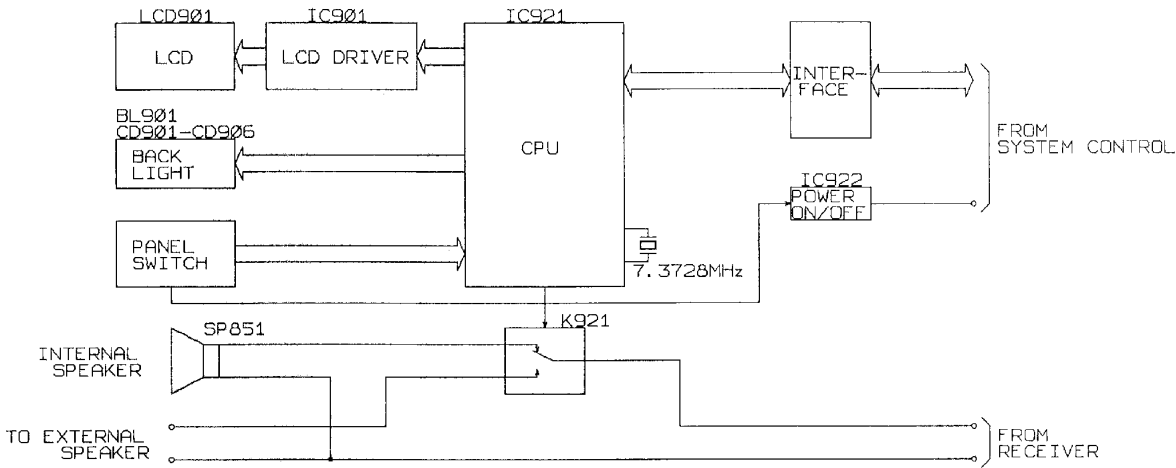
Signal lines from the operating control switches (GRP DWN, VOL UP, etc.) on the Display board enter the Control Panel board at J921. These active-low lines are diode protected by CD921 thru CD931 and pulled up to 5 volts by R921 thru R932. All lines, with the exception of the POWER switch, connect directly to microcontroller IC921.

The POWER switch is handled differently from the rest of the switch lines. A dual D-type flip-flop (IC922) is used to debounce the switch and provide a toggle action to the push-button power switch. The POWER switch on the Display board is tied to the Control Panel board at J921-A7 (PWR). The PWR line is diode protected (CD942) and tied to the preset (PR) line of IC922. Power (A +) is applied to the flip-flops and is also used to hold both preset (PR) lines high.

When power is applied to the radio, the Q output (IC922-5) is preset to zero which holds the clock (CK) input (IC922-11) low. The Q output of the second flip-flop (IC922-9) is also preset to zero, which is applied to the input of transistor switch TR938, causing the POW ON(-) output to be held high indicating a power off condition. The Q(-) line (IC922-8) is now high and is fed back to the D input of the flip-flop (IC922-12) ready to be clocked in when CK goes high.

When the POWER switch is pressed, the PWR line is held low and starts to discharge C932 through R941. As the voltage decreases across C932, the preset (PR) line (IC922-4) will go low causing the Q output (IC922-5) to go high. The high on the Q output causes a one to be clocked into the second flip-flop causing its Q output to go high, turning on TR938. When TR938 is turned on, POWER ON (-) goes low signalling a power-on condition. At the same time TR938 is turned on, the Q(-) output of the flip-flop goes low causing the D input (IC922-12) to be driven low. The next time the POWER switch is pressed, the zero will be clocked into the flip-flop causing TR928 to turn off.

SCAN MODEL



SYSTEM MODEL

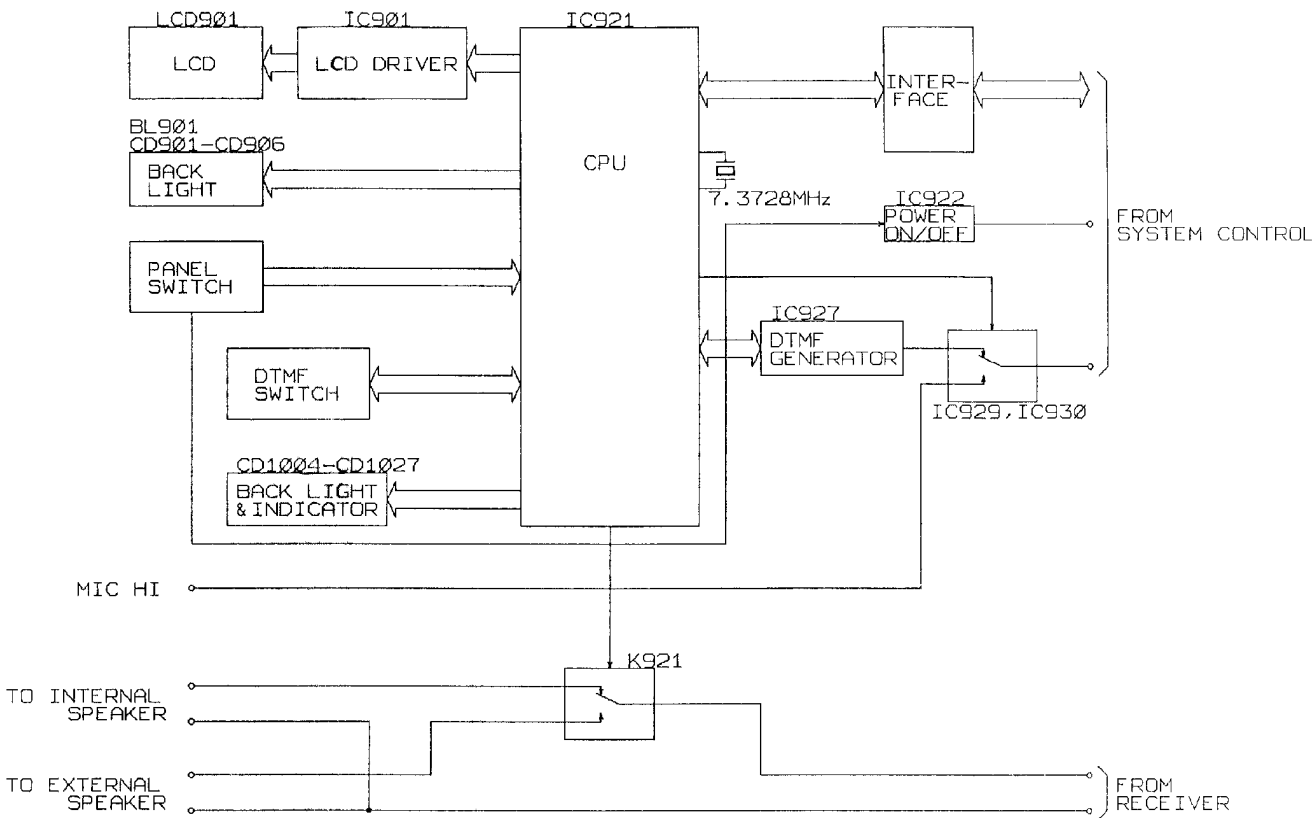


Figure 1 - Front Assembly Block Diagrams

Backlight levels of the LCD and operating controls are set by current switches TR922 and TR924. The switches complete the path from + 9 volts, through the backlight diodes on the Display board and back to ground. Return current from the backlight LEDs flows into the Control Panel board at J921-B7 (BKLT) and is tied to the current switches through R948 and R949. The BK HI (backlight high) and BK LO (backlight low) lines from the microcontroller (IC921-53 & -54) are connected to switch drivers TR923 and TR925. Depending on the levels of BK LO and BK HI, the two current switches are turned on (or off) in different combinations, effectively placing different values of resistance (R948 and R949) in the return path. Four different backlight levels are possible.

Serial data (SER Tx DATA) enters the board at P921-1 pin 1 and is filtered and diode protected before being tied to the microcontroller RXD input (IC921-24). The SER Tx DATA line is also connected to the MDT connector (J924-A1).

Serial data generated by the microcontroller (IC921-25) is applied to driver TR931 which controls open-collector driver TR930. The output of TR930 is filtered and connected to P921-1 pin 2 and J924-A2.

If the microcontroller has data to send over the serial link, it lowers the SER RQST (serial request) line (IC921-52). When SER RQST is lowered it causes open-collector driver TR932 to pull the SER RQST line (J924-A3) low.

The microcontroller clock frequency is set by X921 which is connected to IC921 pins 34 & 35. Jumper F and capacitor C949 are used to shift the oscillator frequency when required. Should the 7.3728 MHz frequency become incompatible with any units in the system, jumper F may be removed to shift the frequency.

An optional external alarm may be controlled by the radio through the EXTERNAL ALARM line (J924-B1). When the microcontroller lowers the ALARM (IC921-51) line, open-collector driver TR935 turns on and activates the external equipment.

The radio will support an internal or external speaker system. Relay K921 determines the audio path between the speaker connector P922 and the MDT connector J923. The relay is controlled by the microcontroller INT line (IC921-50). When this line is high, driver TR937 is turned on keeping K921 energized and routing audio to the external speaker. When INT is low, TR937 is off and the internal speaker is selected.

## DISPLAY BOARD

The Display board contains the LCD, display decoder/driver, indicators, front panel controls, and the backlight unit. The Display board interfaces directly to the Panel Control board through connector P901.

The LCD has eight fourteen-segment alphanumeric characters and nine status indicators. Serial data to be displayed by the LCD comes from the microcontroller bus through the Panel Control Board and is applied to IC901-1. The clock and load pulses are applied to the LCD decoder/driver at pins 2 (SCL) and 12 (VLCD). Backlighting is provided for the LCD and the VOLUME, GROUP and SYSTEM controls. Diodes CD901 thru CD906 illuminate the operating controls and LED backlight unit BL901 illuminates the LCD. Chip resistors R901 and R904 are used to limit the current through the backlight diodes.

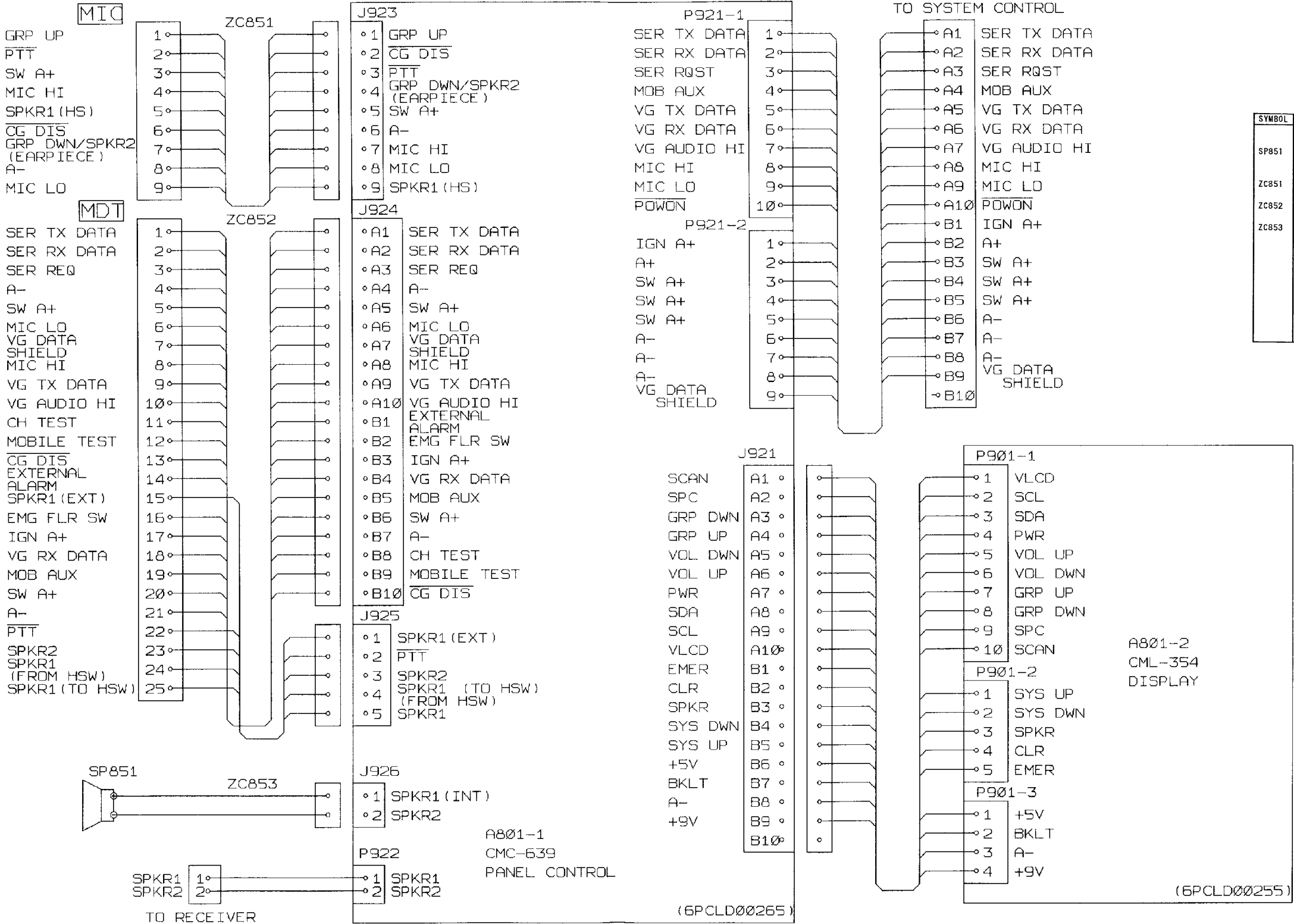
There are four backlight levels (including off) that are available. These levels are set on the Panel Control board through the use of two current switches. The amount of current flowing from + 9V through the back-light diodes and returning to ground (BKLT) is controlled by the settings of the current switches on the Panel Control board.

The operating control switches on the front panel are all tied to a bus through connector P901 to the Panel Control board. The switch states are read by the microcontroller on the Control Panel board.

## DTMF SW BOARD (SYSTEM MODEL)

The Dual Tone Multiple Frequency (DTMF) Switch board contains the keypad function LEDs (CD1004 - CD1015), button backlight LEDs (CD1016 - CD1027), and DTMF switches. This board interfaces to the Panel Control board through connector P1001.

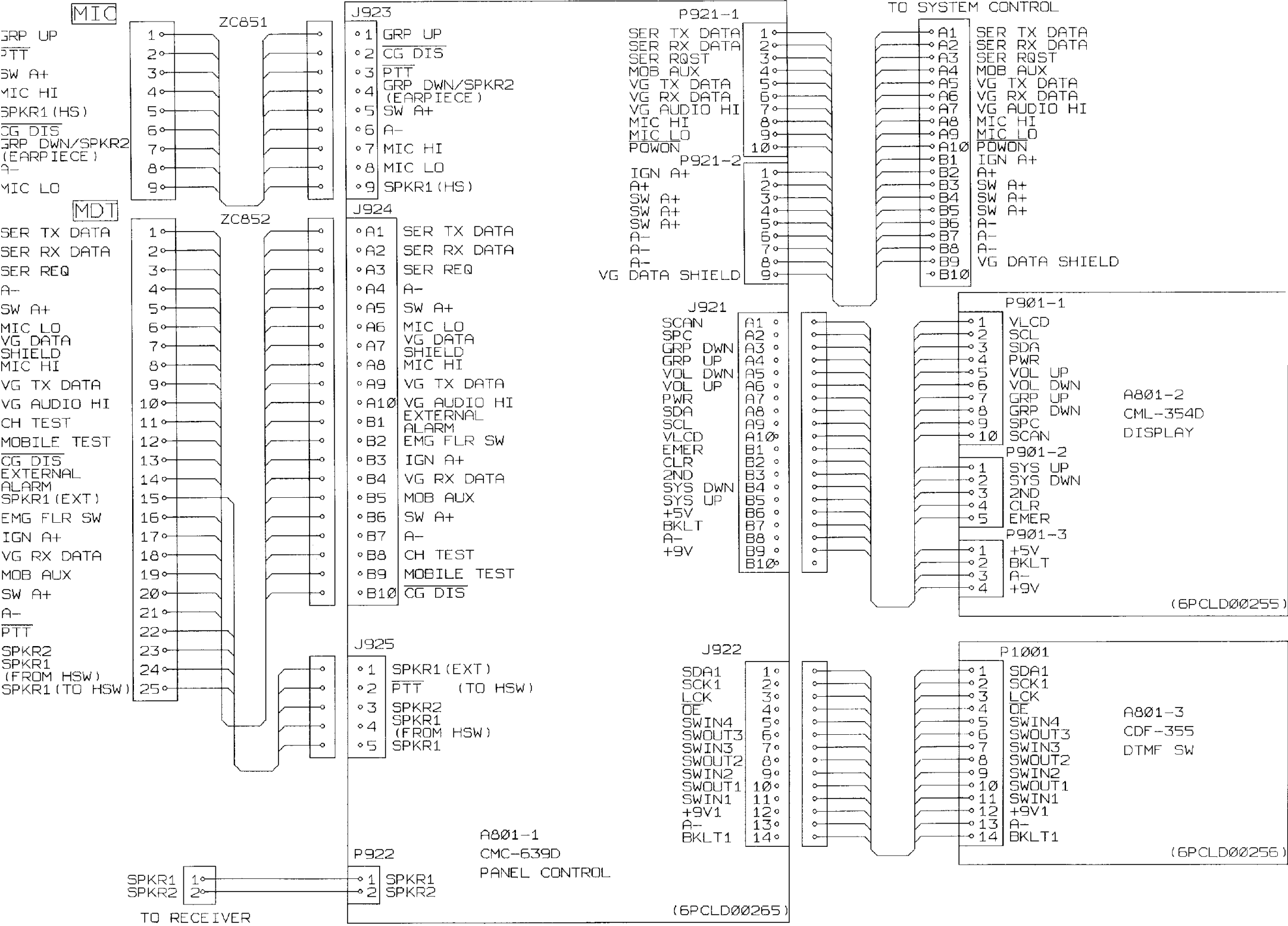
A pair of cascaded shift registers (IC1001 and IC1002) are used to receive the serial data signal (SDA1) and provide a parallel output used to drive the keypad function LEDs. The backlight LEDs for the keypad buttons are controlled with the BKLT1 line from the Panel Control Board through P1001-14. The backlight LED control circuitry is similar to that explained under DISPLAY BOARD above. The DTMF switch states are read by the microcontroller on the Panel Control board.



PARTS LIST

ALPHANUMERIC FMD  
PANEL  
(SCAN MODEL)  
B19/CMD-507

SYMBOL	GE PART NO.	DESCRIPTION
SP851	B19/5USAF00077	Speaker: 16 ohms.
ZC851	B19/6ZCLD00032	Cable Assembly.
ZC852	B19/6ZCLD00112	Cable Assembly.
ZC853	B19/6ZCLD00046	Cable Assembly.



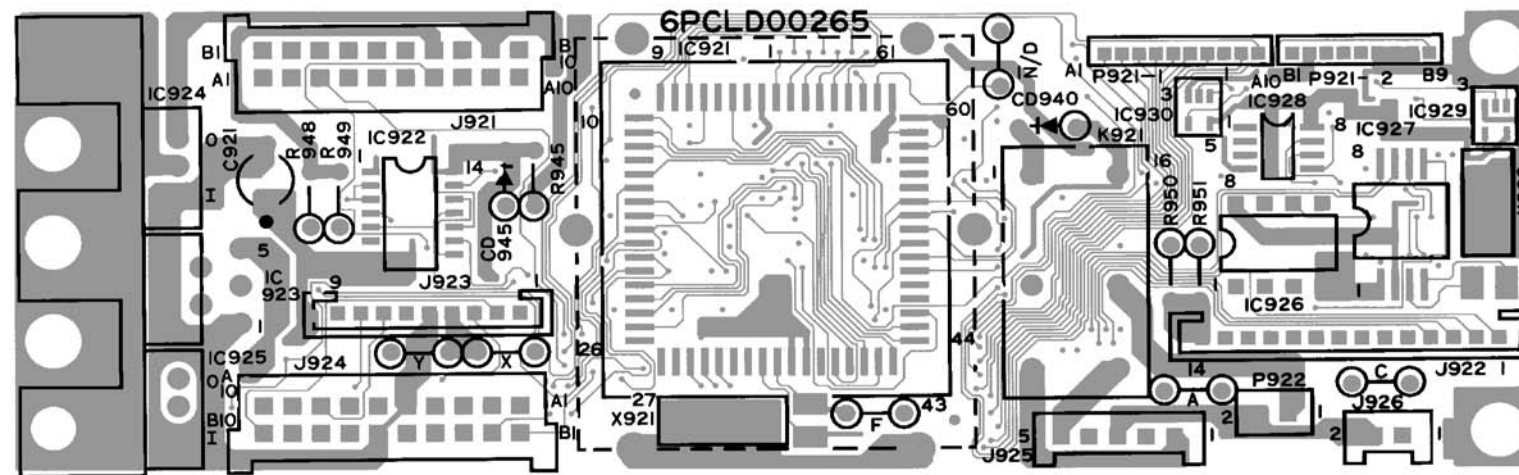
PARTS LIST

ALPHANUMERIC FMD  
PANEL  
(SYSTEM MODEL)  
B19/CMD-507D

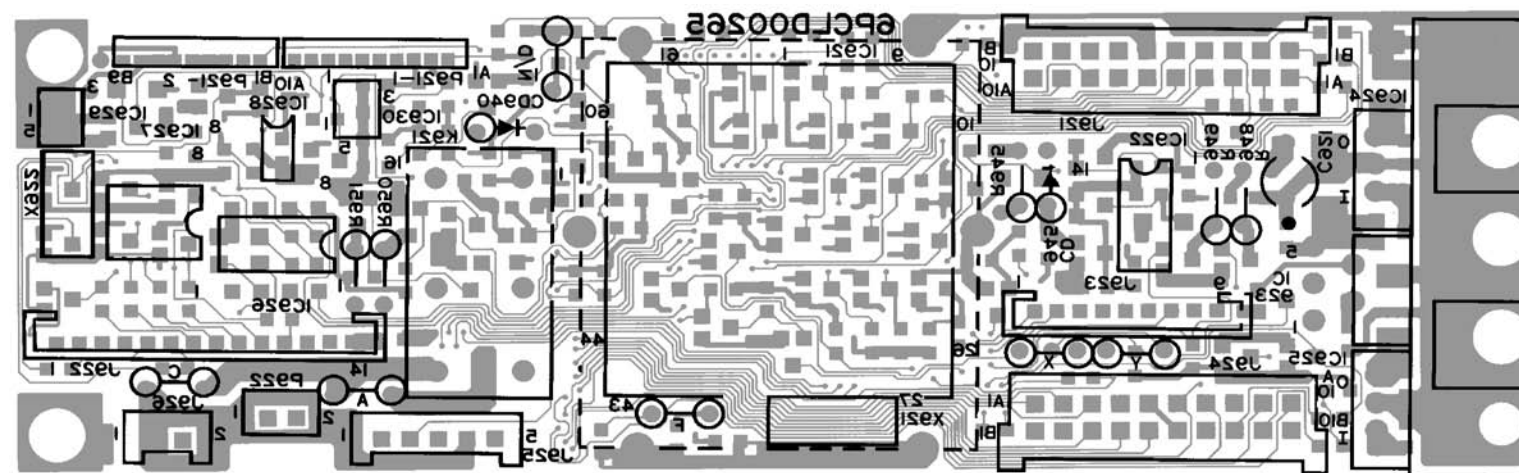
SYMBOL	GE PART NO.	DESCRIPTION
ZC851	B19/6ZCLD00032	----- PLUGS ----- Cable Assembly.
ZC852	B19/6ZCLD00112	Cable Assembly.

PANEL (SYSTEM MODEL)  
B19/CMD-507D

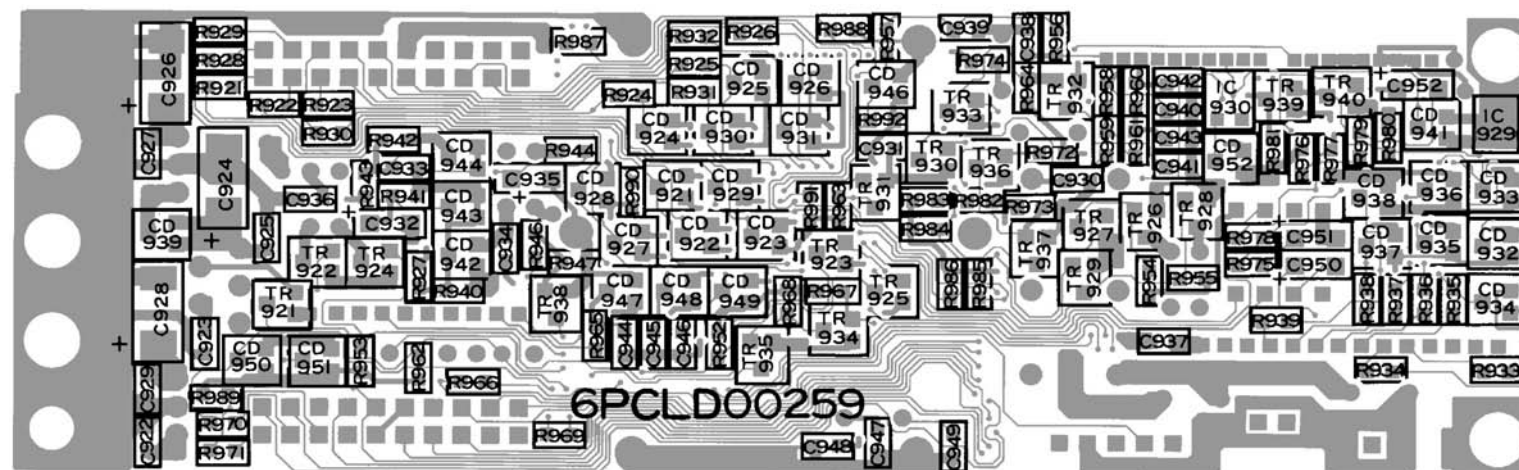
COMPONENT SIDE



SOLDER SIDE



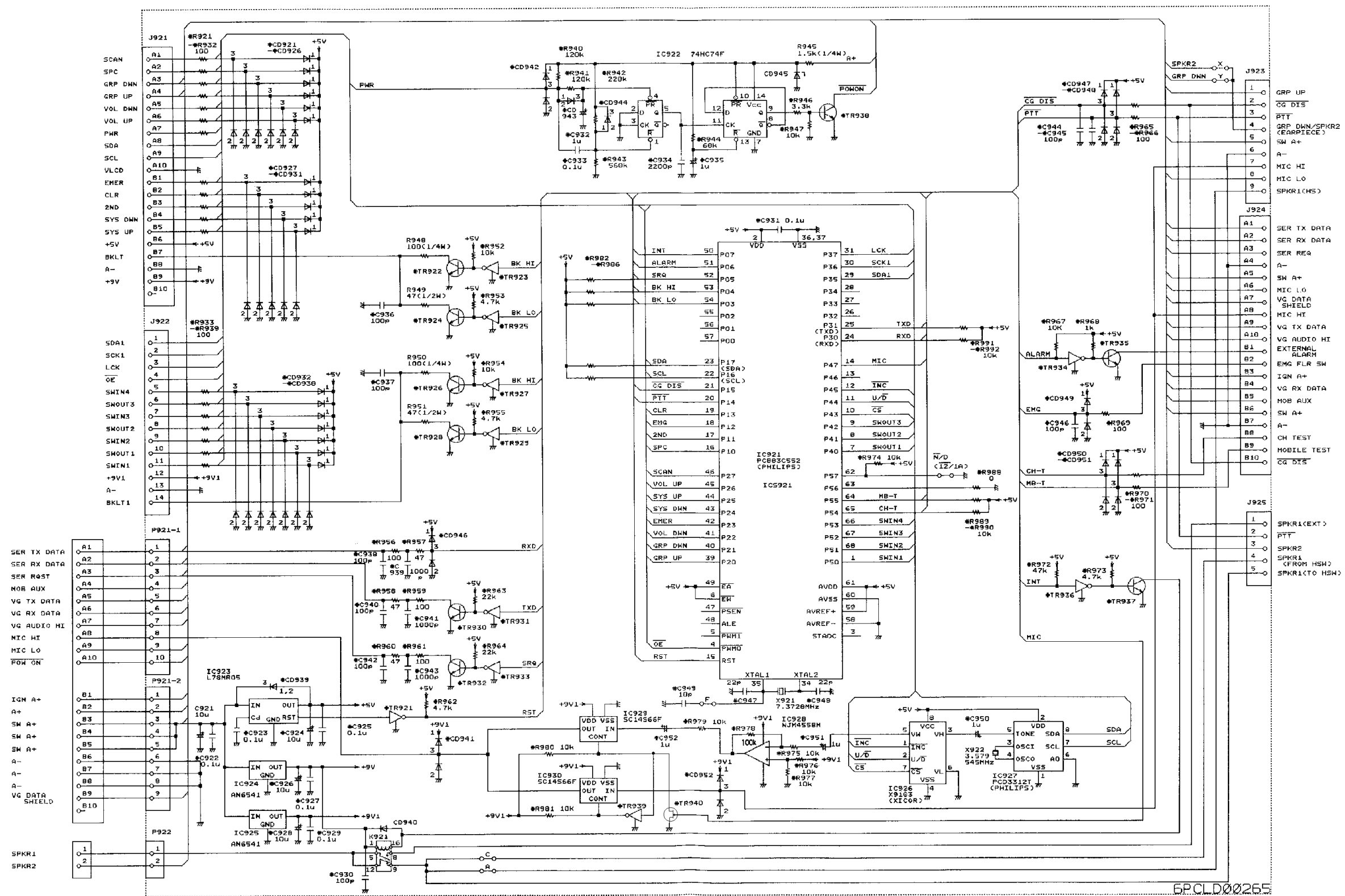
CHIP COMPONENT SIDE (THROUGH BOARD VIEW)



PANEL CONTROL BOARD  
B19/CMC-639 (SCAN MODEL)  
B19/CMC-639D (SYSTEM MODEL)



6



PANEL CONTROL (SYSTEM MODEL)  
B19/CMC-639D



PARTS LIST  
ALPHANUMERIC FMD  
PANEL CONTROL  
(SCAN MODEL)  
B19/CMC-639

SYMBOL	GE PART NO.	DESCRIPTION
		- - - - - CAPACITORS - - - - -
C921	B19/5CEAA01864	Electrolytic: 10uF, ±20%, 25VDCW.
C922 and C923	B19/5CAAD01586	Ceramic: 0.1uF, +80% -20%, 25VDCW.
C924	B19/5CSAA00298	Tantalum: 10uF, ±10%, 16VDCW.
C925	B19/5CAAD01586	Ceramic: 0.1uF, +80% -20%, 25VDCW.
C926	B19/5CSAA00298	Tantalum: 10uF, ±10%, 16VDCW.
C927	B19/5CAAD01586	Ceramic: 0.1uF, +80% -20%, 25VDCW.
C930	B19/5CAAD00839	Ceramic: 100pF, ±5%, 50VDCW, temp coef 0±30 PPM.
C931	B19/5CAAD01586	Ceramic: 0.1uF, +80% -20%, 25VDCW.
C932	B19/5CEAA02249	Tantalum: 1uF, ±10%, 16VDCW.
C933	B19/5CAAD01586	Ceramic: 0.1uF, +80% -20%, 25VDCW.
C934	B19/5CAAD00946	Ceramic: 2200pF, ±10%, 50VDCW, temp coef 0±15%.
C935	B19/5CEAA02249	Tantalum: 1uF, ±10%, 16VDCW.
C936	B19/5CAAD00839	Ceramic: 100pF, ±5%, 50VDCW, temp coef 0±30 PPM.
C938	B19/5CAAD00838	Ceramic: 100pF, ±5%, 50VDCW, temp coef 0±30 PPM.
C939	B19/5CAAD00838	Ceramic: 1000pF, ±10%, 50VDCW, temp coef 0±15%.
C940	B19/5CAAD00839	Ceramic: 100pF, ±5%, 50VDCW, temp coef 0±30 PPM.
C941	B19/5CAAD00838	Ceramic: 1000pF, ±10%, 50VDCW, temp coef 0±15%.
C942	B19/5CAAD00839	Ceramic: 100pF, ±5%, 50VDCW, temp coef 0±30 PPM.

SYMBOL	GE PART NO.	DESCRIPTION
C943	B19/5CAAD00838	Ceramic: 1000pF, ±10%, 50VDCW, temp coef 0±15%.
C944 thru C946	B19/5CAAD00839	Ceramic: 100pF, ±5%, 50VDCW, temp coef 0±30 PPM.
C947 and C948	B19/5CAAD00840	Ceramic: 22pF, ±5%, 50VDCW, temp coef 0±15 PPM.
C949	B19/5CAAD00953	Ceramic: 10pF, ±5%, 50VDCW, temp coef 0±15 PPM.
CD921 thru CD931	B19/STXAD00330	- - - - - DIODES - - - - - Silicon, fast recovery (2 diodes in series): sim to TOSHIBA 1SS226.
CD939	B19/STXAD00291	Silicon, fast recovery (2 diodes in cathode common): sim to TOSHIBA 1SS184.
CD940	B19/STXAN00068	Silicon, fwd current 1A, 200PIV: sim to SANKEN EM01ZW.
CD942	B19/STXAD00330	Silicon, fast recovery (2 diodes in series): sim to TOSHIBA 1SS226.
CD943 and CD944	B19/STXAD00291	Silicon, fast recovery (2 diodes in cathode common): sim to TOSHIBA 1SS184.
CD945	B19/STXAE00568	Zener, 500mW, 5V: sim to HITACHI HZ5C1.
CD946 thru CD951	B19/STXAD00330	Silicon, fast recovery (2 diodes in series): sim to TOSHIBA 1SS226.
IC921	B19/5DDDEG00031	- - - - - INTEGRATED CIRCUITS - - - - - Microcomputer: sim to PHILIPS S87C552.
IC922	B19/5DAAJ00852	Flip-Flops: sim to MOTOROLA MC74HC74AF.
IC923	B19/5DDCC00024	Linear, Positive Voltage Regulator: sim to SANYO L78MR05.
IC924	B19/5DAAJ00581	Linear, Positive Voltage Regulator: sim to MOTOROLA MC7809CT.
J921	B19/5JWAV00116	- - - - - CONNECTORS - - - - - Connector: 20 pins.
J923	B19/5JWAV00117	Connector: 9 pins.
J924	B19/5JWAV00116	Connector: 20 pins.

SYMBOL	GE PART NO.	DESCRIPTION
J925	B19/5JJAL00090	Connector: 5 pins.
J926	B19/5JWAV00120	Connector: 2 pins.
K921	B19/5KLAD00703	- - - - - RELAYS - - - - - Relay, DC9V: sim to NATIONAL DSP1-DC9V.
P921	B19/6ZCLD00104	- - - - - PLUGS - - - - - Cable Assembly.
P922	B19/6ZCLD00040	Cable Assembly.
R921 thru R932	B19/5RDAC02447	- - - - - RESISTORS - - - - - Metal film: 100 ohms, ±5%, 100VDCW, 1/10W.
R940 and R941	B19/5RDAC02487	Metal film: 120K ohms, ±5%, 100VDCW, 1/10W.
R942	B19/5RDAC02453	Metal film: 220K ohms, ±5%, 100VDCW, 1/10W.
R943	B19/5RDAC02463	Metal film: 560K ohms, ±5%, 100VDCW, 1/10W.
R944	B19/5RDAC02485	Metal film: 68K ohms, ±5%, 100VDCW, 1/10W.
R945	B19/5RDAA01349	Carbon film: 1.5K ohms, ±5%, 1/4W.
R946	B19/5RDAC02462	Metal film: 3.3K ohms, ±5%, 100VDCW, 1/10W.
R947	B19/5RDAC02445	Metal film: 10K ohms, ±5%, 100VDCW, 1/10W.
R948	B19/5RDAA01321	Carbon film: 100 ohms, ±5%, 1/4W.
R949	B19/5RDAA01066	Carbon film: 47 ohms, ±5%, 1/2W.
R952	B19/5RDAC02445	Metal film: 10K ohms, ±5%, 100VDCW, 1/10W.
R953	B19/5RDAC02478	Metal film: 4.7K ohms, ±5%, 100VDCW, 1/10W.
R956	B19/5RDAC02447	Metal film: 100 ohms, ±5%, 100VDCW, 1/10W.
R957 and R958	B19/5RDAC02460	Metal film: 47 ohms, ±5%, 100VDCW, 1/10W.
R959	B19/5RDAC02447	Metal film: 100 ohms, ±5%, 100VDCW, 1/10W.
R960	B19/5RDAC02460	Metal film: 47 ohms, ±5%, 100VDCW, 1/10W.
R961	B19/5RDAC02447	Metal film: 100 ohms, ±5%, 100VDCW, 1/10W.
R962	B19/5RDAC02478	Metal film: 4.7K ohms, ±5%, 100VDCW, 1/10W.

SYMBOL	GE PART NO.	DESCRIPTION
R963 and R964	B19/5RDAC02454	Metal film: 22K ohms, ±5%, 100VDCW, 1/10W.
R965 and R966	B19/5RDAC02447	Metal film: 100 ohms, ±5%, 100VDCW, 1/10W.
R967	B19/5RDAC02445	Metal film: 10K ohms, ±5%, 100VDCW, 1/10W.
R968	B19/5RDAC02446	Metal film: 1K ohms, ±5%, 100VDCW, 1/10W.
R969 thru R971	B19/5RDAC02447	Metal film: 100 ohms, ±5%, 100VDCW, 1/10W.
R972	B19/5RDAC02439	Metal film: 47K ohms, ±5%, 100VDCW, 1/10W.
R973	B19/5RDAC02478	Metal film: 4.7K ohms, ±5%, 100VDCW, 1/10W.
R974	B19/5RDAC02445	Metal film: 10K ohms, ±5%, 100VDCW, 1/10W.
R982 thru R987	B19/5RDAC02445	Metal film: 10K ohms, ±5%, 100VDCW, 1/10W.
R989	B19/5RDAC02581	Metal film: 0 ohms.
R990 thru R993	B19/5RDAC02445	Metal film: 10K ohms, ±5%, 100VDCW, 1/10W.
TR921	B19/5TCAZ00011	- - - - - TRANSISTORS - - - - - Silicon, NPN: sim to SANYO 2SC3398.
TR922	B19/5TDAB00098	Silicon, NPN: sim to NEC 2SD596.
TR923	B19/5TCAZ00011	Silicon, NPN: sim to SANYO 2SC3398.
TR924	B19/5TDAB00098	Silicon, NPN: sim to NEC 2SD596.
TR925	B19/5TCAZ00011	Silicon, NPN: sim to SANYO 2SC3398.
TR930	B19/5TDAB00098	Silicon, NPN: sim to NEC 2SD596.
TR931	B19/5TCAZ00011	Silicon, NPN: sim to SANYO 2SC3398.
TR932	B19/5TDAB00098	Silicon, NPN: sim to NEC 2SD596.
TR933 and TR934	B19/5TCAZ00011	Silicon, NPN: sim to SANYO 2SC3398.
TR935	B19/5TDAB00098	Silicon, NPN: sim to NEC 2SD596.
TR936	B19/5TCAZ00011	Silicon, NPN: sim to SANYO 2SC3398.

PARTS LIST  
ALPHANUMERIC FMD  
PANEL CONTROL  
(SYSTEM MODEL)  
B19/CMC-639D

SYMBOL	GE PART NO.	DESCRIPTION
TR937 and TR938	B19/5TDAB00098	Silicon, NPN: sim to NEC 2SD596.
X921	B19/5XNAM00022	----- CRYSTALS ----- Quartz crystal: 7.3728MHz.

SYMBOL	GE PART NO.	DESCRIPTION
C921	B19/5CEAA01864	----- CAPACITORS ----- Electrolytic: 10uF, ±20%, 25VDCW.
C922 and C923	B19/5CAAD01586	Ceramic: 0.1uF, +80% -20%, 25VDCW.
C924	B19/5CSAA00298	Tantalum: 10uF, ±10%, 16VDCW.
C925	B19/5CAAD01586	Ceramic: 0.1uF, +80% -20%, 25VDCW.
C926	B19/5CSAA00298	Tantalum: 10uF, ±10%, 16VDCW.
C927	B19/5CAAD01586	Ceramic: 0.1uF, +80% -20%, 25VDCW.
C928	B19/5CSAA00298	Tantalum: 10uF, ±10%, 16VDCW.
C929	B19/5CAAD01586	Ceramic: 0.1uF, +80% -20%, 25VDCW.
C930	B19/5CAAD00839	Ceramic: 100pF, ±5%, 50VDCW, temp coef 0±30 PPM.
C931	B19/5CAAD01586	Ceramic: 0.1uF, +80% -20%, 25VDCW.
C932	B19/5CEAA02249	Tantalum: 1uF, ±10%, 16VDCW.
C933	B19/5CAAD01586	Ceramic: 0.1uF, +80% -20%, 25VDCW.
C934	B19/5CAAD00946	Ceramic: 2200pF, ±10%, 50VDCW, temp coef 0±15%.
C935	B19/5CEAA02249	Tantalum: 1uF, ±10%, 16VDCW.
C936 thru C938	B19/5CAAD00839	Ceramic: 100pF, ±5%, 50VDCW, temp coef 0±30 PPM.
C939	B19/5CAAD00838	Ceramic: 1000pF, ±10%, 50VDCW, temp coef 0±15%.
C940	B19/5CAAD00839	Ceramic: 100pF, ±5%, 50VDCW, temp coef 0±30 PPM.
C941	B19/5CAAD00838	Ceramic: 1000pF, ±10%, 50VDCW, temp coef 0±15%.
C942	B19/5CAAD00839	Ceramic: 100pF, ±5%, 50VDCW, temp coef 0±30 PPM.

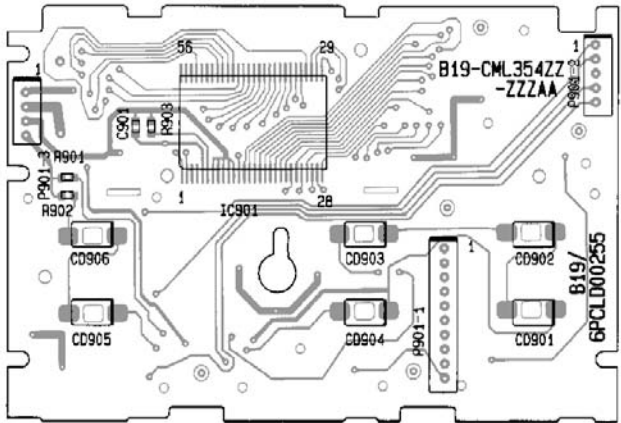
SYMBOL	GE PART NO.	DESCRIPTION
C943	B19/5CAAD00838	Ceramic: 1000pF, ±10%, 50VDCW, temp coef 0±15%.
C944 thru C946	B19/5CAAD00839	Ceramic: 100pF, ±5%, 50VDCW, temp coef 0±30 PPM.
C947 and C948	B19/5CAAD00840	Ceramic: 22pF, ±5%, 50VDCW, temp coef 0±15 PPM.
C949	B19/5CAAD00953	Ceramic: 10pF, ±5%, 50VDCW, temp coef 0±15 PPM.
C950 thru C952	B19/5CEAA02249	Tantalum: 1uF, ±10%, 16VDCW.
CD921 thru CD938	B19/5TXAD00330	----- DIODES ----- Silicon, fast recovery (2 diodes in series): sim to TOSHIBA 1SS226.
CD939	B19/5TXAD00291	Silicon, fast recovery (2 diodes in cathode common): sim to TOSHIBA 1SS184.
CD940	B19/5TXAN00068	Silicon, fwd current 1A, 200PIV: sim to SANKEN EM01ZW.
CD941 and CD942	B19/5TXAD00330	Silicon, fast recovery (2 diodes in series): sim to TOSHIBA 1SS226.
CD943 and CD944	B19/5TXAD00291	Silicon, fast recovery (2 diodes in cathode common): sim to TOSHIBA 1SS184.
CD945	B19/5TXAE00568	Zener, 500mW, 5V: sim to HITACHI HZ5C1.
CD946 thru CD952	B19/5TXAD00330	Silicon, fast recovery (2 diodes in series): sim to TOSHIBA 1SS226.
IC921	B19/5DDEG00031	----- INTEGRATED CIRCUITS ----- Microcomputer: sim to PHILIPS S87C52.
IC922	B19/5DAAJ00852	Flip-Flops: sim to MOTOROLA MC74HC74AF.
IC923	B19/5DDCC00024	Linear, Positive Voltage Regulator: sim to SANYO L78MR05.
IC924 and IC925	B19/5DAAJ00581	Linear, Positive Voltage Regulator: sim to MOTOROLA MC7809CT.
IC926	B19/5DDBY00064	EEPOT: sim to XICOR X9103.

SYMBOL	GE PART NO.	DESCRIPTION
IC927	B19/5DDEG00033	DTMF generators: sim to PHILIPS PCD3312T.
IC928	B19/5DAAN00109	Linear, OP AMP: sim to New JRC NJM4558M.
IC929 and IC930	B19/5DAAJ00962	Bilateral switch: sim to MOTOROLA SC14S66F.
J921	B19/5JWAV00116	----- CONNECTORS ----- Connector: 20 pins.
J922	B19/5JWAV00145	Connector: 14 pins.
J923	B19/5JWAV00117	Connector: 9 pins.
J924	B19/5JWAV00116	Connector: 20 pins.
J925	B19/5JJAL00090	Connector: 5 pins.
K921	B19/5KLAD00703	----- RELAYS ----- Relay, DC9V: sim to NATIONAL DSP1-DC9V.
P921	B19/6ZCLD00104	----- PLUGS ----- Cable Assembly.
P922	B19/6ZCLD00040	Cable Assembly.
R921 thru R939	B19/5RDAC02447	----- RESISTORS ----- Metal film: 100 ohms, ±5%, 100VDCW, 1/10W.
R940 and R941	B19/5RDAC02487	Metal film: 120K ohms, ±5%, 100VDCW, 1/10W.
R942	B19/5RDAC02453	Metal film: 220K ohms, ±5%, 100VDCW, 1/10W.
R943	B19/5RDAC02463	Metal film: 560K ohms, ±5%, 100VDCW, 1/10W.
R944	B19/5RDAC02485	Metal film: 68K ohms, ±5%, 100VDCW, 1/10W.
R945	B19/5RDAA01349	Carbon film: 1.5K ohms, ±5%, 1/4W.
R946	B19/5RDAC02462	Metal film: 3.3K ohms, ±5%, 100VDCW, 1/10W.
R947	B19/5RDAC02445	Metal film: 10K ohms, ±5%, 100VDCW, 1/10W.
R948	B19/5RDAA01321	Carbon film: 100 ohms, ±5%, 1/4W.
R949	B19/5RDAA01066	Carbon film: 47 ohms, ±5%, 1/2W.
R950	B19/5RDAA01321	Carbon film: 100 ohms, ±5%, 1/4W.
R951	B19/5RDAA01066	Carbon film: 47 ohms, ±5%, 1/2W.

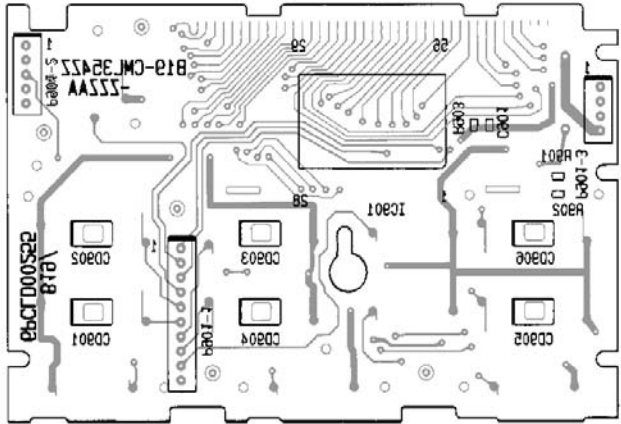
SYMBOL	GE PART NO.	DESCRIPTION
R952	B19/5RDAC02445	Metal film: 10K ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R953	B19/5RDAC02478	Metal film: 4.7K ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R954	B19/5RDAC02445	Metal film: 10K ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R955	B19/5RDAC02478	Metal film: 4.7K ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R956	B19/5RDAC02447	Metal film: 100 ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R957 and R958	B19/5RDAC02460	Metal film: 47 ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R959	B19/5RDAC02447	Metal film: 100 ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R960	B19/5RDAC02460	Metal film: 47 ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R961	B19/5RDAC02447	Metal film: 100 ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R962	B19/5RDAC02478	Metal film: 4.7K ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R963 and R964	B19/5RDAC02454	Metal film: 22K ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R965 and R966	B19/5RDAC02447	Metal film: 100 ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R967	B19/5RDAC02445	Metal film: 10K ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R968	B19/5RDAC02446	Metal film: 1K ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R969 thru R971	B19/5RDAC02447	Metal film: 100 ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R972	B19/5RDAC02439	Metal film: 47K ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R973	B19/5RDAC02478	Metal film: 4.7K ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R974	B19/5RDAC02445	Metal film: 10K ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R978	B19/5RDAC02449	Metal film: 100K ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R986	B19/5RDAC02445	Metal film: 10K ohms, $\pm 5\%$ , 100VDCW, 1/10W.
R988	B19/5RDAC02581	Metal film: 0 ohms.
R990 thru R993	B19/5RDAC02445	Metal film: 10K ohms, $\pm 5\%$ , 100VDCW, 1/10W.
TR921	B19/5TCAZ00011	----- TRANSISTORS ----- Silicon, NPN: sim to SANYO 2SC3398.
TR922	B19/5TDAB00098	Silicon, NPN: sim to NEC 2SD596.

SYMBOL	GE PART NO.	DESCRIPTION
TR923	B19/5TCAZ00011	Silicon, NPN: sim to SANYO 2SC3398.
TR924	B19/5TDAB00098	Silicon, NPN: sim to NEC 2SD596.
TR925	B19/5TCAZ00011	Silicon, NPN: sim to SANYO 2SC3398.
TR926	B19/5TDAB00098	Silicon, NPN: sim to NEC 2SD596.
TR927	B19/5TCAZ00011	Silicon, NPN: sim to SANYO 2SC3398.
TR928	B19/5TDAB00098	Silicon, NPN: sim to NEC 2SD596.
TR929	B19/5TCAZ00011	Silicon, NPN: sim to SANYO 2SC3398.
TR930	B19/5TDAB00098	Silicon, NPN: sim to NEC 2SD596.
TR931	B19/5TCAZ00011	Silicon, NPN: sim to SANYO 2SC3398.
TR932	B19/5TDAB00098	Silicon, NPN: sim to NEC 2SD596.
TR933 and TR934	B19/5TCAZ00011	Silicon, NPN: sim to SANYO 2SC3398.
TR935	B19/5TDAB00098	Silicon, NPN: sim to NEC 2SD596.
TR936	B19/5TCAZ00011	Silicon, NPN: sim to SANYO 2SC3398.
TR937 and TR938	B19/5TDAB00098	Silicon, NPN: sim to NEC 2SD596.
TR939	B19/5TCAZ00011	Silicon, NPN: sim to SANYO 2SC3398.
TR940	B19/5TCAZ00012	MOSFET, NCH-ENH: sim to SANYO 2SK536.
X921	B19/5XNAM00022	----- CRYSTALS ----- Quartz crystal: 7.3728MHz.
X922	B19/5XNAM00023	Quartz crystal: 3.579545MHz.

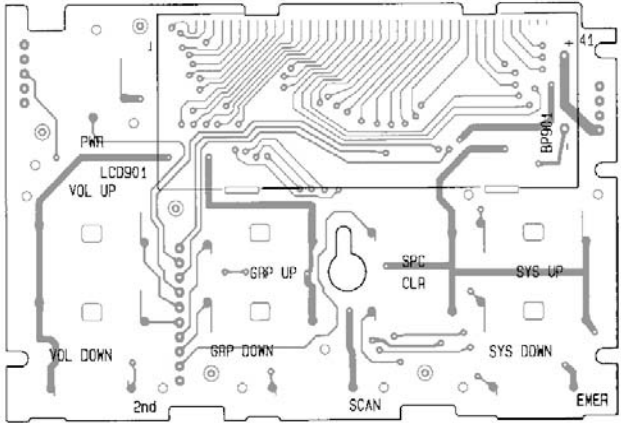
COMPONENT SIDE



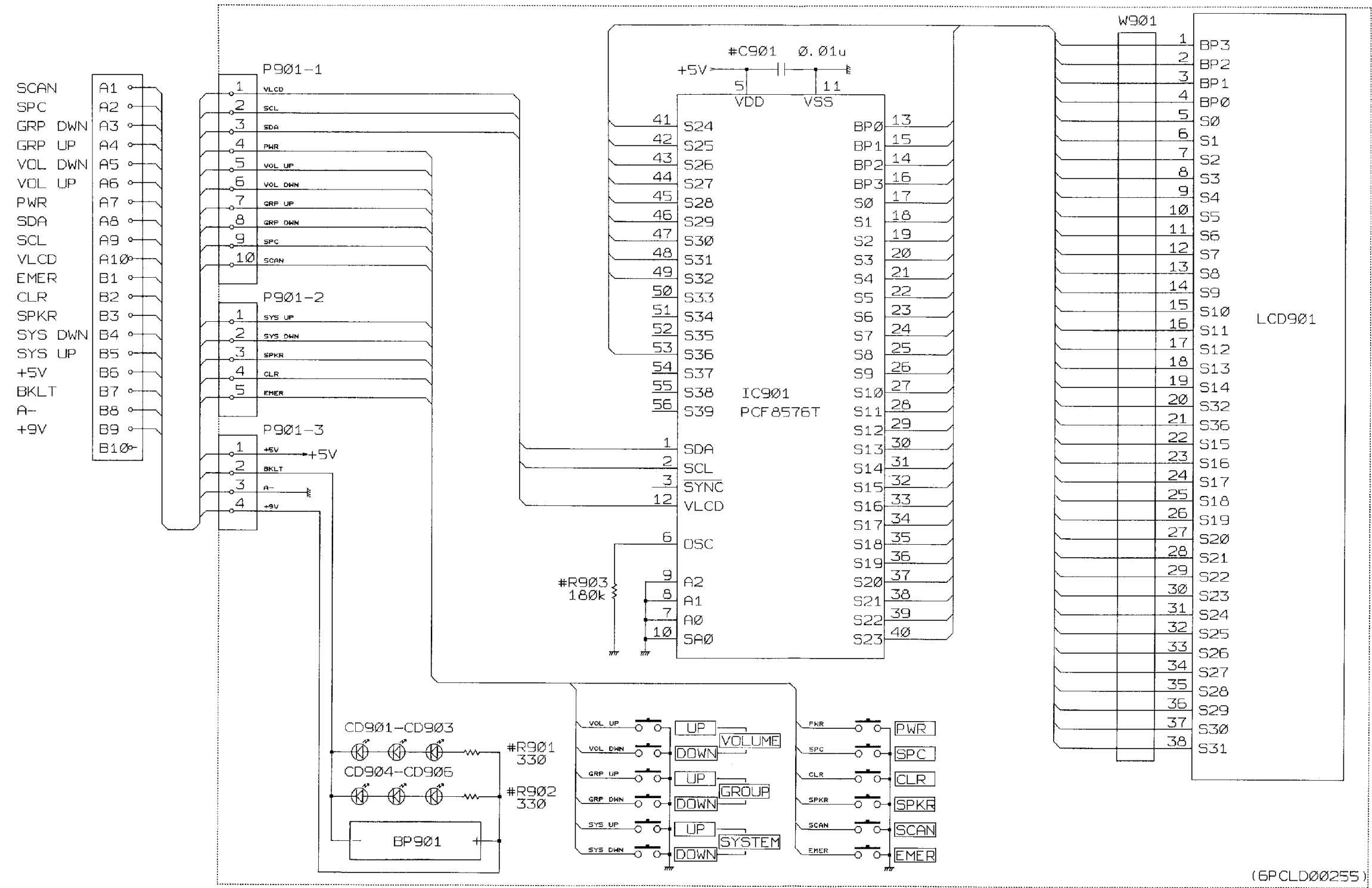
SOLDER SIDE

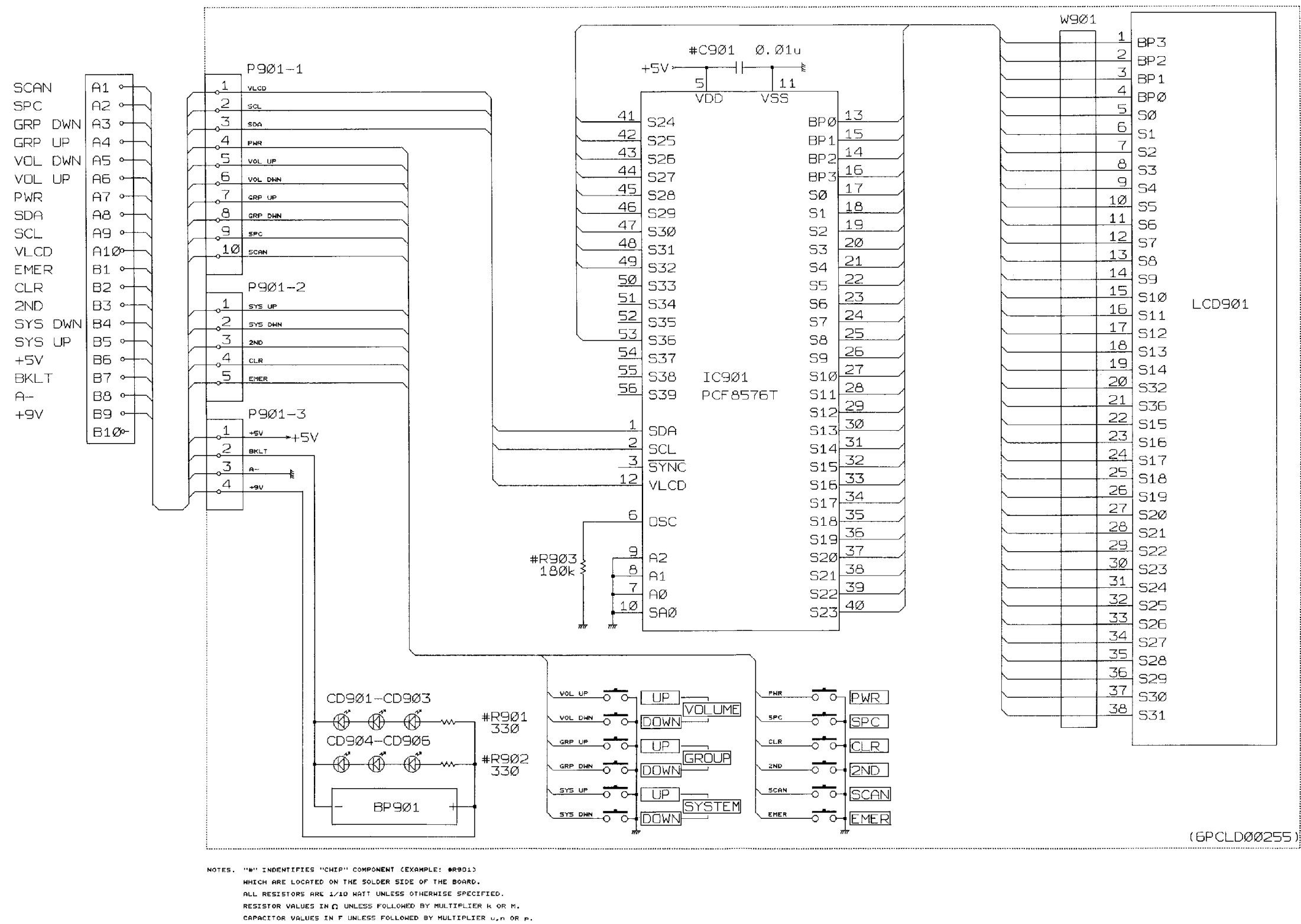


DISPLAY SIDE



DISPLAY BOARD  
B19/CML-354 (SCAN)  
B19/CML-354D (SYSTEM)



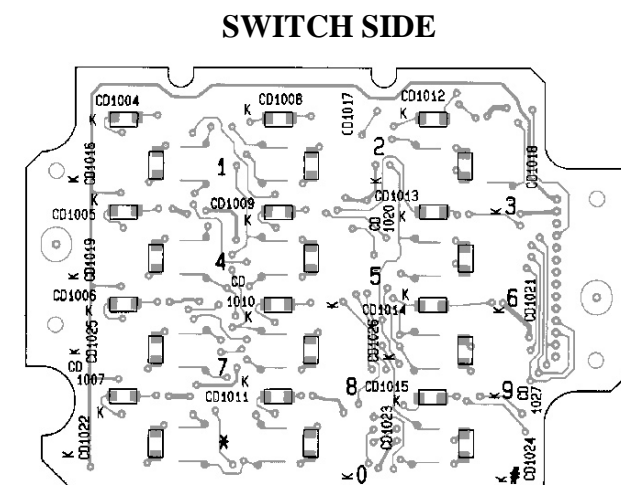
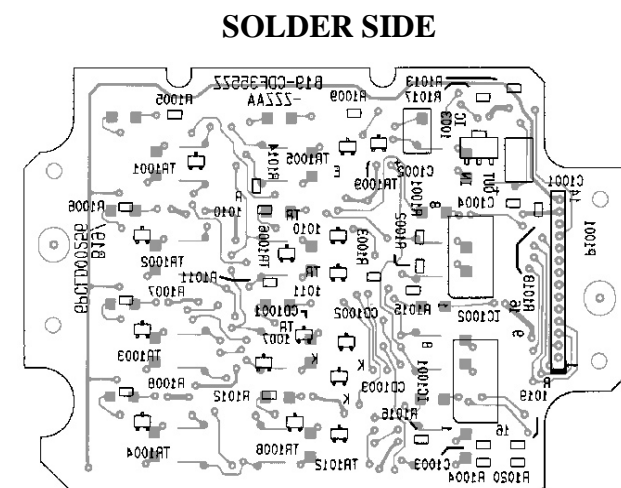
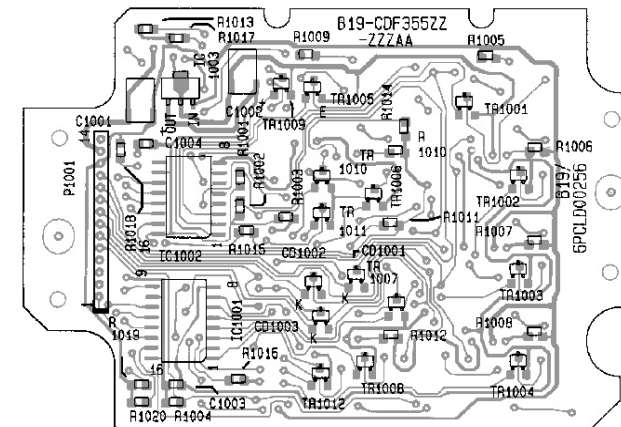


DISPLAY (SYSTEM MODEL)  
B19/CML-354D

### COMPONENT SIDE

ALPHANUMERIC FMD  
DISPLAY (SYSTEM MODEL)  
B19/CML-354D

SYMBOL	GE PART NO.	DESCRIPTION
BL901	B19/6WZLD00001	Backlight Unit.
C901	B19/5CAAA02094	----- CAPACITORS ----- Ceramic: 0.01uF, $\pm 10\%$ , 50VDCW.
CD901 thru CD906	B19/5TXBG00039	----- DIODES ----- Diode, Optoelectronic: orange, sim to STANLEY AA2222S.
IC901	B19/5DDEG00032	----- INTEGRATED CIRCUITS ----- LCD Driver: sim to PHILIPS PCF8576T.
LCD901	B19/5JWGE00010	----- DISPLAY ----- LCD
P901	B19/6ZCLD00034	----- PLUG ----- Cable Assembly.
R901 and R902	B19/5RDAC02555	----- RESISTORS ----- Metal film: 270 ohms, $\pm 5\%$ , 100 VDCW, 1/10W.
R903	B19/5RDAC02459	Metal film: 180K ohms, $\pm 5\%$ , 100 VDCW, 1/10W.
W901	B19/6JWLD00002	----- CONNECTORS ----- Rubber connector.



**DTMF SW BOARD (SYSTEM MODEL)**  
**B19/CDF-355**



PARTS LIST  
ALPHANUMERIC FMD  
DTMF SW(SYSTEM MODEL)  
B19/CDF-355

SYMBOL	GE PART NO.	DESCRIPTION
C1001 and C1002	B19/5CABP00001	----- CAPACITORS ----- Electrolytic: 1uF, ±20%, 50VDCW.
C1003 and C1004	B19/5CAAD02131	Ceramic: 0.01uF, +80% -20%, 25VDCW.
CD1001 thru CD1003	B19/5TXCW00063	----- DIODES ----- Silicon, fast recovery: sim to ROHM DA116.
CD1004 thru CD1015	B19/5TZAW00147	Diode, Optoelectronic: red, sim to STANLEY BR1101.
CD1016 thru CD1027	B19/5TZAW00148	Diode, Optoelectronic: orange, sim to STANLEY AA1101.
IC1001 and IC1002	B19/5DDAE02014	----- INTEGRATED CIRCUITS ----- Shift Register: sim to TOSHIBA TC74HC595AF.
IC1003	B19/5DAAN00535	Linear, Positive Voltage Regulator: sim to New JRC NJM78L05UA.
P1001	B19/6ZCLD00103	----- PLUGS ----- Cable Assembly.
R1001 thru R1004	B19/5RZBW00067	----- RESISTORS ----- Metal film: 10K ohms, ±5%, 100VDCW, 1/10W.
R1005 thru R1016	B19/5RZBW00065	Metal film: 3.3K ohms, ±5%, 100VDCW, 1/10W.
R1017 thru R1020	B19/5RZBW00066	Metal film: 270 ohms, ±5%, 100VDCW, 1/10W.

SYMBOL	GE PART NO.	DESCRIPTION
TR1001 thru TR1012	B19/5TZCU00059	----- TRANSISTORS ----- Silicon, NPN: sim to ROHM DTC114YK.